

July 2008

FDS6675BZ

P-Channel PowerTrench® MOSFET

-30V, -11A, 13mΩ

General Description

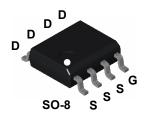
This P-Channel MOSFET is producted using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance.

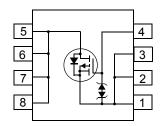
This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.



Features

- Max $r_{DS(on)} = 13m\Omega$ at $V_{GS} = -10V$, $I_D = -11A$
- Max $r_{DS(on)}$ = 21.8m Ω at V_{GS} = -4.5V, I_D = -9A
- Extended V_{GS} range (-25V) for battery applications
- HBM ESD protection level of 5.4 KV typical (note 3)
- High performance trench technology for extremely low r_{DS(nn)}
- High power and current handing capability
- RoHS Compliant





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V_{DS}	Drain to Source Voltage		-30	V
V_{GS}	Gate to Source Voltage		±25	V
ı	Drain Current -Continuous	(Note 1a)	-11	۸
ID	-Pulsed		-55	Α
	Power Dissipation for Single Operation	(Note 1a)	2.5	
P_{D}		(Note 1b)	1.2	W
		(Note 1c)	1.0	
T _J , T _{STG}	Operating and Storage Temperature		-55 to 150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance , Junction to Ambient (Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance , Junction to Case (Note 1)	25	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS6675BZ	FDS6675BZ	13"	12mm	2500 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	ncteristics					
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = -250 \mu A$, $V_{GS} = 0 V$	-30			V
$\frac{\Delta B_{VDSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = -250μA, referenced to 25°C		-20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -24V, V_{GS} = 0V$			-1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 25V, V_{DS} = 0V$			±10	μΑ

On Characteristics (Note 2)

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \mu A$	-1	-2	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = -250 μ A, referenced to 25°C		15.7		mV/°C
	V _{GS} = -10V , I _D = -11A		10.8	13.0		
r _{DO(++})	Drain to Source On Resistance	$V_{GS} = -4.5V, I_D = -9A$		17.4	21.8	mΩ
r _{DS(on)} Drain to Source On Resistance	V_{GS} = -10V, I_{D} = -11A T_{J} = 125°C		15.0	18.8	11122	
g _{FS}	Forward Transconductance	$V_{DS} = -5V$, $I_{D} = -11A$		34		S

Dynamic Characteristics

C _{iss}	Input Capacitance	\\ - 45\\ \\ - 0\\	1855	2470	pF
C _{oss}	Output Capacitance	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz	335	450	pF
C _{rss}	Reverse Transfer Capacitance	111112	330	500	pF

Switching Characteristics (Note 2)

t _{d(on)}	Turn-On Delay Time			3.0	10	ns
t _r	Rise Time	V_{DD} = -15V, I_{D} = -11A V_{GS} = -10V, R_{GS} = 6 Ω		7.8	16	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -10V, R_{GS} = 602$		120	200	ns
t _f	Fall Time			60	100	ns
Qg	Total Gate Charge	$V_{DS} = -15V, V_{GS} = -10V,$ $I_{D} = -11A$		44	62	nC
Q_g	Total Gate Charge	V 45V.V 5V		25	35	nC
Q_{gs}	Gate to Source Gate Charge	$V_{DS} = -15V, V_{GS} = -5V,$ $I_{D} = -11A$		7.2		nC
Q _{gd}	Gate to Drain Charge			11.4		nC

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = -2.1A$	-0.7	-1.2	V
t _{rr}	Reverse Recovery Time	$I_F = -11A$, di/dt = 100A/ μ s		42	ns
Q _{rr}	Reverse Recovery Charge	$I_F = -11A$, di/dt = 100A/ μ s		30	nC

1: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 50°C/W when mounted on a 1 in² pad of 2 oz copper



b)105°C/W when mounted on a .04 in² pad of 2 oz copper



c) 125°C/W when mounted on a minimun pad

Scale 1:1 on letter size paper

- 2: Pulse Test:Pulse Width <300 us, Duty Cycle < 2.0%
- 3: The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

Typical Characteristics T_J = 25°C unless otherwise noted

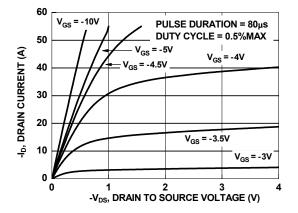


Figure 1. On Region Characteristics

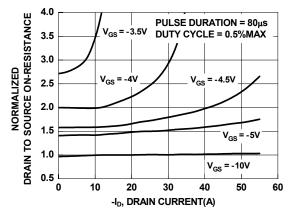


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

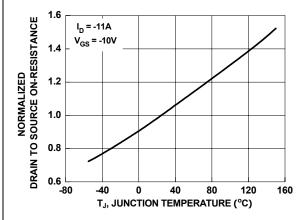


Figure 3. Normalized On Resistance vs Junction Temperature

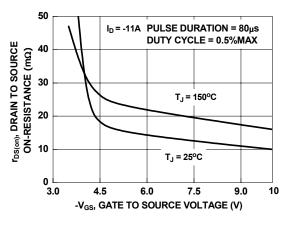


Figure 4. On-Resistance vs Gate to Source Voltage

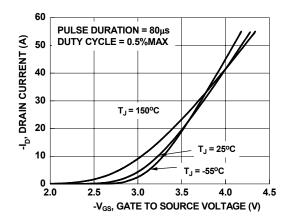


Figure 5. Transfer Characteristics

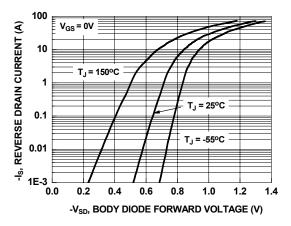


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics T_J = 25°C unless otherwise noted

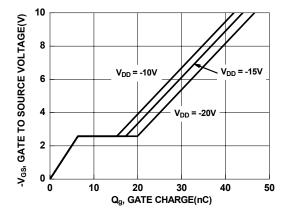
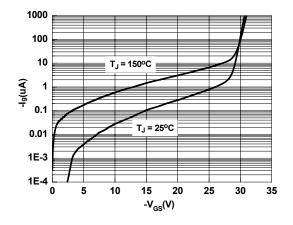


Figure 7. Gate Charge Characteristics

Figure 8. Capacitance vs Drain to Source Voltage



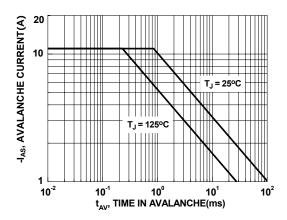
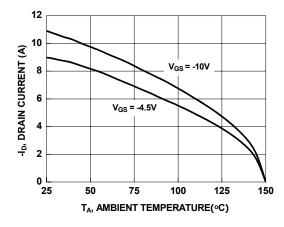


Figure 9. I_g vs V_{GS}

Figure 10. Unclamped Inductive Switching Capability



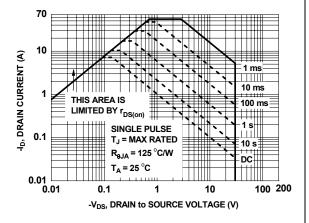


Figure 11. Maximum Continuous Drain Current vs
Ambient Temperature

Figure 12. Forward Bias Safe Operating Area



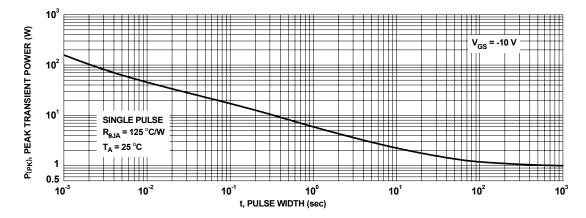


Figure 13. Junction-to-Case Transient Thermal Response Curve

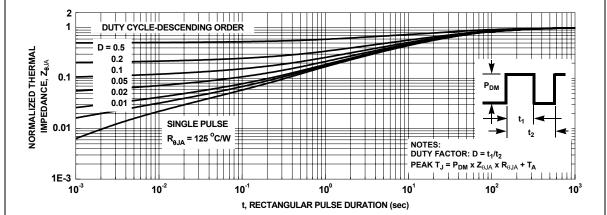


Figure 14. Junction-to-Ambient Transient Thermal Response Curve





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Rev. 135